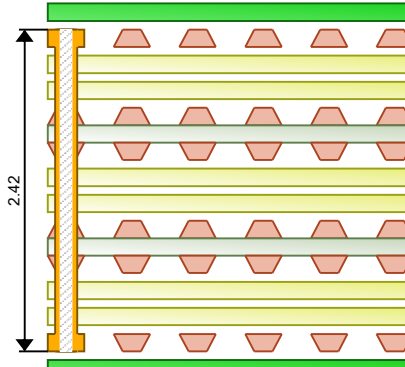


Layer	Stack up	Supplier	Supplier Description	Description	Type	Tg	εr	Base Thickness	Processed Thickness
1		Electra Polymers		Liquid Photolmageable Mask	SolderMask			4.000	
				Copper Foil	Copper			0.018	0.038
2		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.063
		Shanghai Nanya	NY2150	PrePreg 7628	Dielectric	150.000	4.200	0.187	0.168
3		Shanghai Nanya	NY2150	NY2150 Core	FR4	150.000	4.200	0.710	0.710
								0.035	0.035
4		Shanghai Nanya	NY2150	PrePreg 7628	Dielectric	150.000	4.200	0.187	0.161
		Shanghai Nanya	NY2150	PrePreg 7628	Dielectric	150.000	4.200	0.187	0.161
5		Shanghai Nanya	NY2150	NY2150 Core	FR4	150.000	4.200	0.710	0.710
								0.035	0.035
6		Shanghai Nanya	NY2150	PrePreg 7628	Dielectric	150.000	4.200	0.187	0.168
		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.063
6				Circuitfoil	Copper Foil			0.018	0.038
		Electra Polymers		Liquid Photolmageable Mask	SolderMask			4.000	



Copper Thickness = 0.216 | Dielectric Thickness = 2.203 | Solder Mask Thickness = 0.050 | Stack Up Thickness = 2.419 | Stack Up Thickness with Soldermask = 2.469 | Stack Up Cost = 52.00 |

Drill Image	1st Layer	2nd Layer	Column Position
	1	6	1

Notes

StackName: Mlb6_Standard2.4mm_TraX	Version:	Revision:	Modification:	Date of Revision:	Editor	Page 1/1
Date: 2017/05/04	Associated Documents:					
Author: H. Ndala						
Department: Tech.						
Site: Diep River						